UNISONIC TECHNOLOGIES CO., LTD

UT2312 Power MOSFET

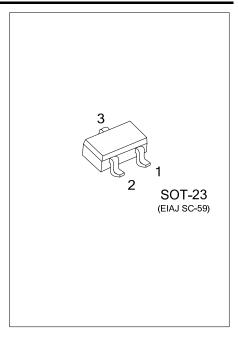
5A, 20V N-CHANNEL ENHANCEMENT MODE MOSFET

■ DESCRIPTION

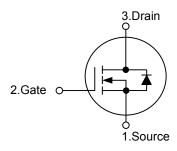
The **UT2312** uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

■ FEATURES

- * $R_{DS(ON)}$ < 33 m Ω @ V_{GS} =4.5V, I_D =5.0 A
- * $R_{DS(ON)}$ < 40 m Ω @ V_{GS} =2.5 V, I_{D} =4.0 A
- * Advanced trench process technology
- * Excellent thermal and electrical capabilities
- * High density cell design for ultra low on-resistance



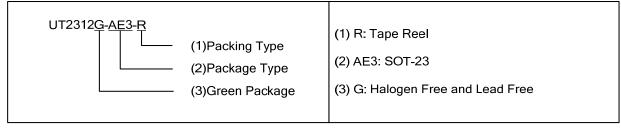
■ SYMBOL



■ ORDERING INFORMATION

Ordering Number	Package	Pin Assignment			Dooking	
		1	2	3	Packing	
UT2312G-AE3-R	SOT-23	S	G	D	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_A =25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	20	V
Gate-Source Voltage	V_{GSS}	±8	V
Continuous Drain Current	I _D	5	Α
Pulsed Drain Current	I _{DM}	15	Α
Power Dissipation (T _A =25°C) (Note 2)	P_D	1.25	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL RATINGS		UNIT	
Junction to Ambient	θ_{JA}	100	°C/W	

■ ELECTRICAL CHARACTERISTICS (T_A =25°C, unless otherwise specified)

			1		1	
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} =0V, I_{D} =250 μA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20 V, V _{GS} =0 V			1.0	μΑ
Gate-Body Leakage, Forward	I_{GSS}	V_{GS} =±8V, V_{DS} = 0 V			±100	nA
ON CHARACTERISTICS						
Gate-Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.45			V
Static Drain–Source On–Resistance	R _{DS(ON)}	V_{GS} =4.5V, I_{D} =5.0 A		25	33	mΩ
		V_{GS} =2.5 V, I_{D} =4.0 A		35	40	mΩ
On-State Drain Current	$I_{D(ON)}$	V _{DS} ≥10 V, V _{GS} = 4.5 V	15			Α
Forward Transconductance	g fs	$V_{DS} = 5V, I_{D} = 5.0 A$		20		S
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}			900		pF
Output Capacitance	Coss	V_{DS} =10V, V_{GS} =0V, f=1.0MHz		140		pF
Reverse Transfer Capacitance	C _{RSS}			100		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_{G}			11	14	nC
Gate Source Charge	Q_GS	V_{DS} =10V, V_{GS} =4.5V, I_{D} =3.6A		1.4		nC
Gate Drain Charge	Q_GD			2.2		nC
Turn-ON Delay Time	t _{D(ON)}			15	25	ns
Turn-ON Rise Time	t _R	V_{DD} =10V, I_{D} =1A, R_{L} =10 Ω		40	60	ns
Turn-OFF Delay Time	t _{D(OFF)}	V_{GEN} =4.5V, R_G =6 Ω		48	70	ns
Turn-OFF Fall-Time	t _F			31	45	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Drain-Source Diode Forward Voltage	V_{SD}	I _S =1.0 A,V _{GS} =0 V		0.75	1.2	V
Max. Diode Forward Current	I _S				1.6	Α
Notice D. Leaders Leave 1995 4 000						

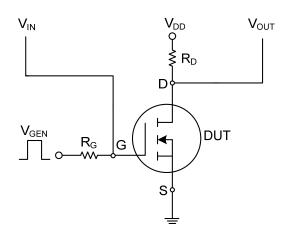
Notes: Pulse test; pulse width ≤ 300µs, duty cycle ≤ 2%

^{2.} Surface mounted on 1 in 2 copper pad of FR4 board.

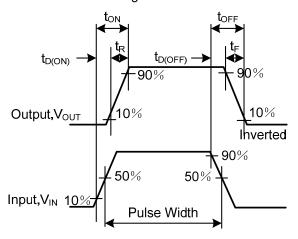
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■ TEST CIRCUIT AND WAVEFORM

Switching Test Circuit



Switching Waveforms



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